

TECHNICAL SPECIFICATION

MODEL NO : ED060SC4

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Customer's Confirmation

Customer

Date

By

PVI's Confirmation

Confirmed By

Prepared By



Revision History

Rev.	Issued Date	Revised Contents
1.0	May,13,2008	New
		Add
		Page 8 6-1)Absolute maximum rating
		Page 8 6-3) Panel DC characteristics
		Border supply
		Page 16 10. Reliability test
		Stylus Tapping add Test should be done with a bezel
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2.0	Nov 01 0000	
2.0	Nov.21.2008	Modify
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TECHNICAL SPECIFICATION

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1. Application

The display is a TFT active matrix electrophoretic display, with associated interface and control logic, and a reference system design.

The 6" active area contains 800x600 pixels, and has full 1~4 bit display capabilities.

An integrated circuit containing interface, timing and control logic is supplied with each panel.

2. Features

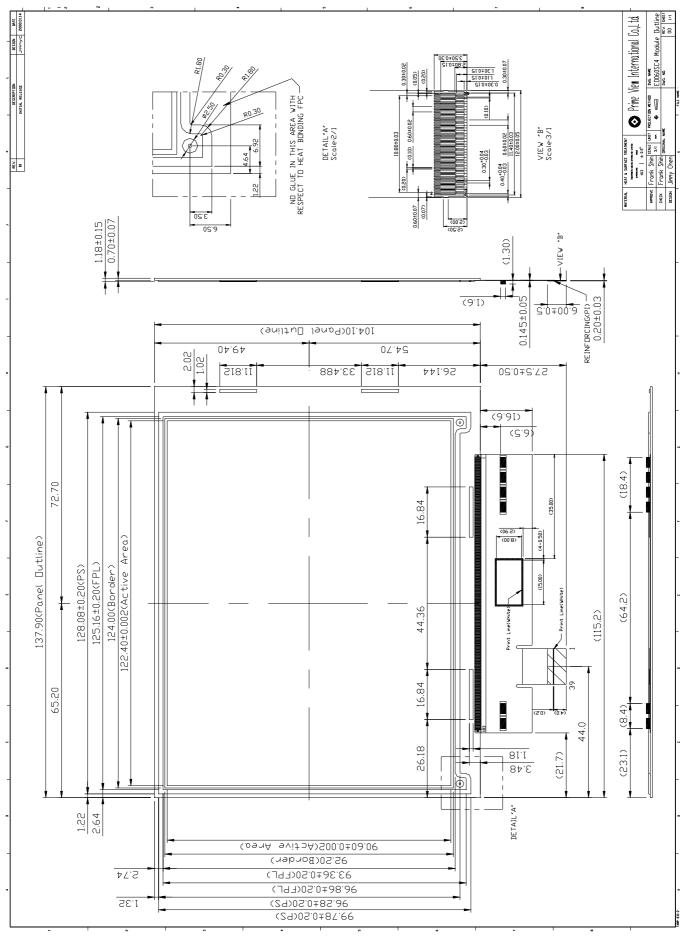
- High contrast TFT electrophoretic
- ➢ 800x600 display
- ➢ High reflectance
- Ultra wide viewing angle
- ➢ Ultra low power consumption
- > Pure reflective mode
- ➢ Bi-stable
- Commercial temperature range
- Landscape, portrait mode
- Antiglare hard-coated front-surface

3. Mechanical Specifications

Parameter	Parameter Specifications		Remark
Screen Size	6.0 (4:3 diagonal)	Inch	
Display Resolution	800 (H) ×600(V)	Pixel	
Active Area	122.4 (H)×90.6 (V)	mm	
Pixel Pitch	0.153 (H)×0.151 (V)	mm	
Pixel Configuration	Rectangle		
Outline Dimension	137.90(W)×104.10(H)×1.18(D) (panel area height) 137.90(W)×104.10(H)×2.0 (D) (FPC area height with capacitor)	mm	Panel height is measured without released film
Module Weight	35±5	g	



4. Mechanical Drawing of EPD Module



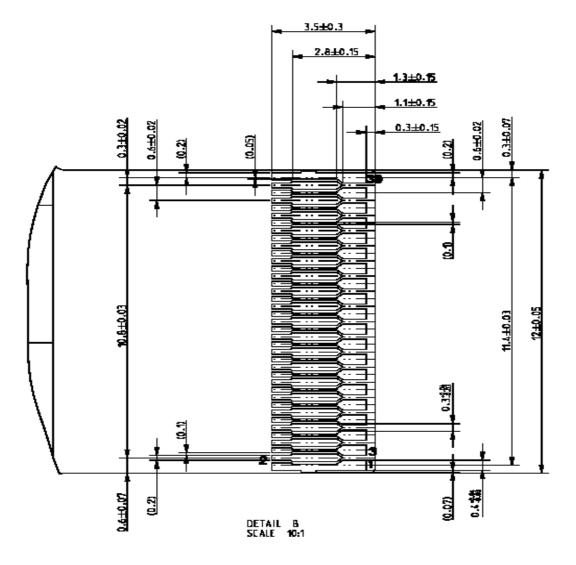
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5.Input/Ouput Interface 5-1)Pin Assignment

Pin #	Signal	Description
1	VNEG	Negative power supply source driver
2	VPOS	Positive power supply source driver
3	VSS	Ground
4	VDD	Digital power supply drivers
5	CL	Clock source driver
6	LE	Latch enable source driver
7	OE	Output enable source driver
8	SHR	Shift direction source driver
9	NC	NO Connection
10	NC	NO Connection
11	SPH	Start pulse source driver
12	D0	Data signal source driver
13	D1	Data signal source driver
14	D2	Data signal source driver
15	D3	Data signal source driver
16	D4	Data signal source driver
17	D5	Data signal source driver
18	D6	Data signal source driver
19	D7	Data signal source driver
20	NC	NO Connection
21	NC	NO Connection
22	VCOM	Common connection
23	GVDD	Positive power supply gate driver
24	GVEE	Negative power supply gate driver
25	NC	NO Connection
26	NC	NO Connection
27	GMODE2	Output mode selection gate driver
28	GMODE1	Output mode selection gate driver
29	RL	Shift direction gate driver
30	U1CE2	Cascade sequence 1st gate driver
31	U1CE1	Cascade sequence 1st gate driver
32	U1SPV	Start pulse 1st gate driver
33	U1CKV	Clock 1st gate driver
34	VBORDER	Border connection
35	U2CE2	Cascade sequence 2nd gate driver
36	U2CE1	Cascade sequence 2nd gate driver
37	U2SPV	Start pulse 2nd gate driver
38	U2CKV	Clock 2nd gate driver
39	NC	NO Connection

5-2)Panel Electrical Connection

SERVICE	CONNECTOR	TYPE NUMBER	NUMBER OF PINS	MATING CONNECTOR
Interface	JST	39FXL-RSM1-S-H-TB	39	Copper foil 0.3mm pitch
Interface	551	571 XE-R5WIT-5-11-1D	57	copper fon 0.5mm piten



6.Electrical Characteristics

6-1) Panel interface description

This panel is driven by ASIC PVI-6001A or "Apollo" display controller ASIC. See control product specification for details.

6-2) Absolute maximum rating

Parameter	Symbol	Rating	Unit
Logic Supply Voltage	VDD	-0.3 to +7	V
Positive Supply Voltage	V _{POS}	-0.3 to +18	V
Negative Supply Voltage	V _{NEG}	+0.3 to -18	V
Max .Drive Voltage Range	V_{POS} - V_{NEG}	36	V
Supply Voltage	VGG	-0.3 to +45	V
Supply Voltage	VEE	-25.0 to +0.3	V
Supply Range	VGG-VEE	-0.3 to +45	V
Operating Temp. Range	TOTR	0 to +50	°C
Storage Temperature	TSTG	-25 to +70	°C

6-3) Panel DC characteristics

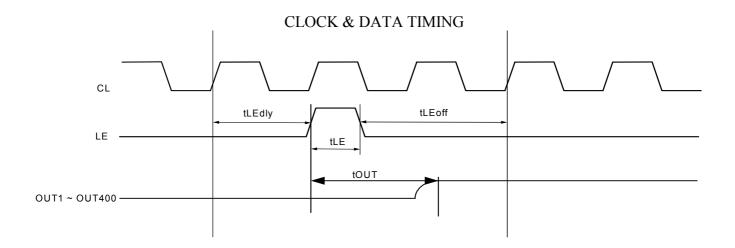
6-3) Panel DC characte	ristics					
Parameter	Symbol	Conditions	Min	Тур	Max	Unit
Signal ground	V_{SS}		-	0	-	V
Logio Valtago oupplu	V_{DD}		3.0	3.3	3.6	V
Logic Voltage supply	I_{VDD}	$V_{DD}=3.3V$	-	0.55	1.1	mA
Cata Nagativa aventiv	GV_EE		-21	-20	-19	V
Gate Negative supply	GI_EE	GV _{EE} =-20V	-	1.3	3.9	mA
Cata Desitiva supply	GV_DD		21	22	23	V
Gate Positive supply	GI_DD	GV_{DD} = 22V	-	0.6	1.8	mA
Source Negative europhy	V_{NEG}		-15.4	-15	-14.6	V
Source Negative supply	I _{NEG}	V _{NEG} = -15V	-	18	36	mA
Course Desitive oursely	V _{POS}		14.6	15	15.4	V
Source Positive supply	I _{POS}	V_{POS} = 15V	-	18	36	mA
Dandan sumulu	X 7	V _{POS} = 15V	14.6	15	15.4	V
Border supply	V_{Border}	V _{NEG} = -15V	-15.4	-15	-14.6	V
Asymmetry source	V _{Asym}	V_{POS} + V_{NEG}	-800	0	800	mV
Common voltage	V _{COM}		-2.5	Adjusted	-1.0	V
Common voltage	I _{COM}		-	0.2	-	mA
Maximum power panel	P _{MAX}		-	-	1250	mW
Standby power panel	P _{STBY}		-	-	0.4	mW
Typical power panel	P _{TYP}		-	600	-	mW
Operating temperature			0	-	50	°C
Storage temperature			-25	-	70	°C
Maximum image update time at 25℃			-	1000	-	ms

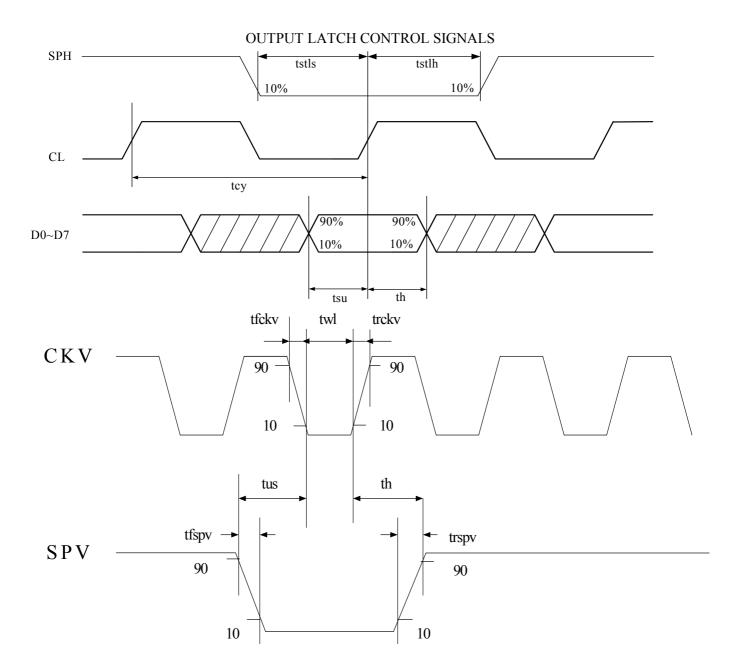
- The maximum power and maximum currents are specified for the worst case power consumption.
- The typical power is measured when "typical images" are displayed
- The standby power is the consumed power when the panel controller is in standby mode.
- The listed electrical/optical characteristics are only guaranteed under the controller & waveform provided by PVI.
- Vcom is recommended to be set in the range of assigned value $\pm 0.1V$

6-4)Panel AC characteristics

VDD=3.0V to 3.6V, unless otherwise specified.

Parameter	Symbol	Min.	Тур.	Max.	Unit	App Pin
Clock frequency	fckv			200	kHz	
Minimum "L" clock pulse width	twL	0.5			us	CKV
Clock rise time	trckv			100	ns	CITY
Clock fall time	tfckv			100	ns	
Data setup time	tSU	100			ns	CKV,
Data hold time	tH	100			ns	SPV
Pulse rise time	trspv			100	ns	SPV
Pulse fall time	tfspv			100	ns	SF V
Clock CL cycle time	tcy	50		DC	ns	
D0 D7, SPH setup time	tsu	8			ns	
D0 D7, SPH hold time	th	1			ns	Below
LE on delay time	tLEdly	40			ns	table
LE high-level pulse width	tLEw	40			ns	
LE off delay time	tLEoff	40			Ns	





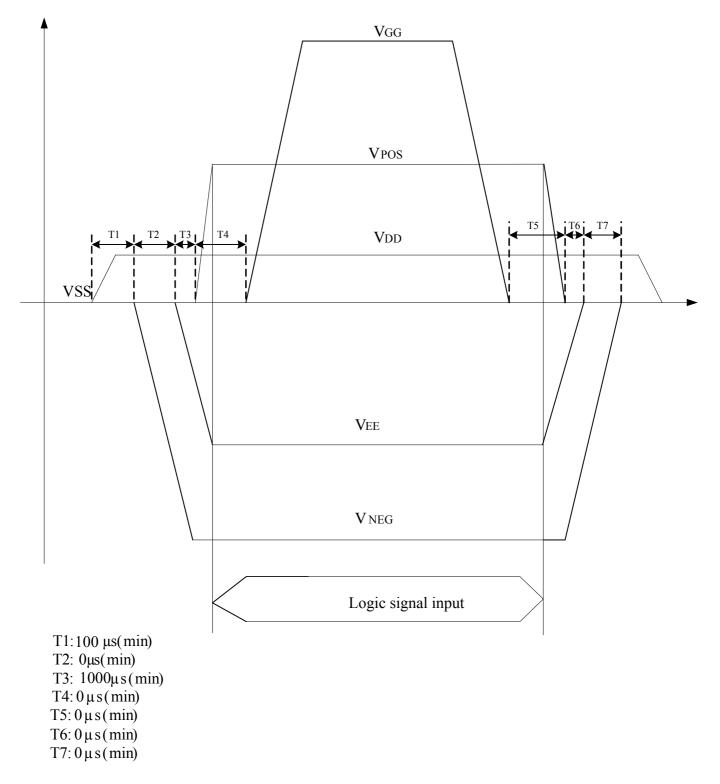
6-5) Power Consumption

Parameter	Symbol	Conditions	TYP	Max	Unit	Remark
Maximum panel power consumption during update.	-	-	-	1250	mW	
Power consumption in standby mode	-	-	-	0.4	mW	
Typical panel power	-	-	600	-	mW	

OPRIME VIEW 7.Power on Sequence

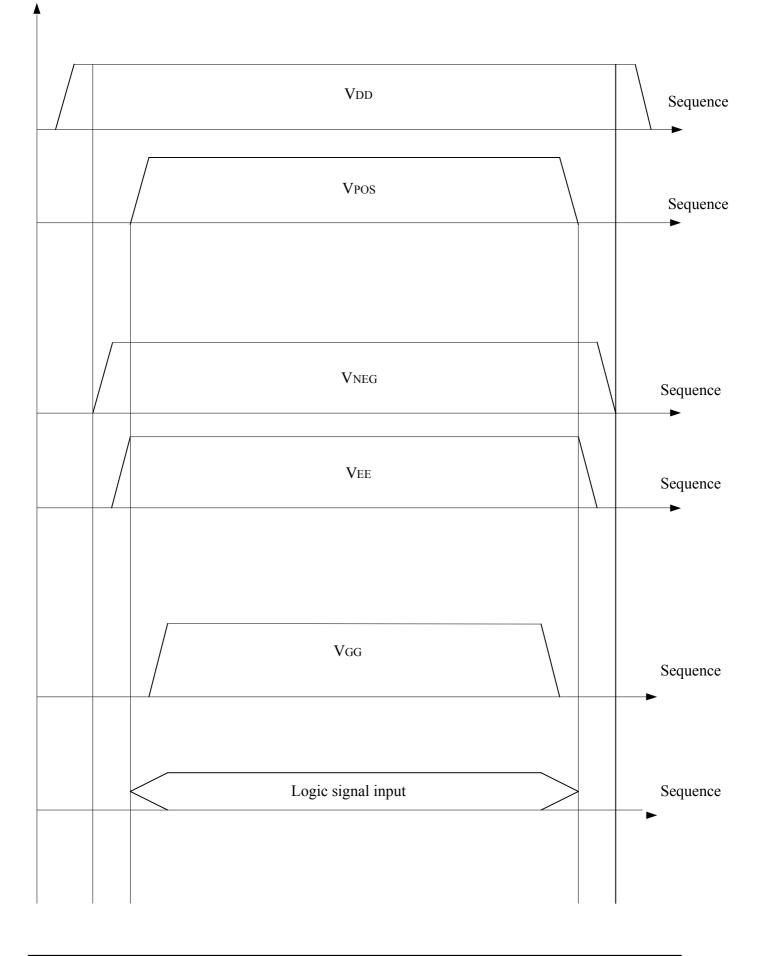
1. VSS \rightarrow VDD \rightarrow VNEG \rightarrow VPOS (Source driver)

2. VEE \rightarrow VGG(Gate driver)





* It is expanded as blew.



8. Optical characteristics

8-1)Specifications

Measurements are made with that the illumination is under an angle of 30 degrees, the detection is perpendicular unless otherwise specified.

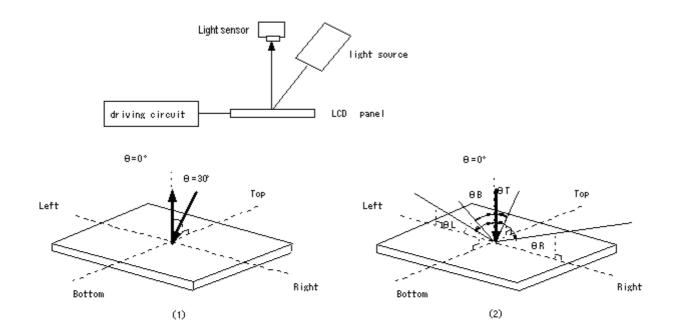
					T =	25°C	
SYMBOL	PARAMETER	CONDITIONS	MIN	TYP.	MAX	UNIT	Note
R	Reflectance	White	30	35	-	%	-
Gn	N _{th} Grey Level	-	-	DS+(WS-DS)×n/(m-1)	-	L*	-
CR	Contrast Ratio	-	6	-	-		-
Т	Update time	2~4-bit mode		1000	_	ms	
update		1-bit mode		540	-	ms	-

WS: White state , DS: Dark state, Gray state from Dark to White :DS $\$ G1 $\$ G2... $\$ Gn... $\$ Gm-2 $\$ WS m:4 $\$ 8 $\$ 16 when 2 $\$ 3 $\$ 4 bits mode

8-2)Definition of contrast ratio

The contrast ratio (CR) is the ratio between the reflectance in a full white area (Rl) and the reflectance in a dark area (Rd):

CR = Rl/Rd

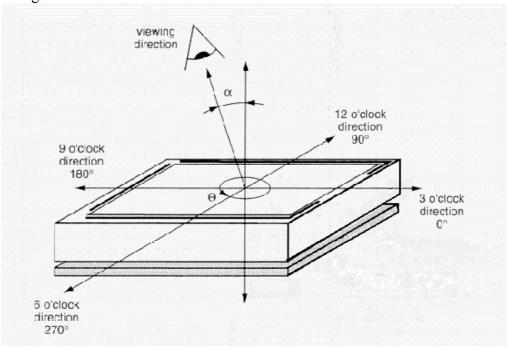


8-3)Reflection Ratio

The reflection ratio is expressed as:

$R = Reflectance Factor_{white board} x (L_{center} / L_{white board})$

 L_{center} is the luminance measured at center in a white area (R=G=B=1). $L_{white board}$ is the luminance of a standard white board. Both are measured with equivalent illumination source. The viewing angle shall be no more than 2 degrees.



$\alpha = declination / \theta = azimuth$

8-4)Waveform

- Wave Form file should be available before panel delivery to customer.
- Wave Form file size should be 64Kb
- Ghosting quality is measured by the reflectance difference between specific area and surface.
 In MU and GU mode, within 3L*
 In GC mode, within 2L*

9.HANDLING, SAFETY AND ENVIROMENTAL REQUIREMENTS

WARNING

The display glass may break when it is dropped or bumped on a hard surface. Handle with care. Should the display break, do not touch the electrophoretic material. In case of contact with electrophoretic material, wash with water and soap.

CAUTION

The display module should not be exposed to harmful gases, such as acid and alkali gases, which corrode electronics components.

Disassembling the display module can cause permanent damage and invalidates the warranty agreements.

Observe general precautions that are common to handling delicate electronic components. The glass can break and front surfaces can easily be damaged. Moreover the display is sensitive to static electricity and other rough environmental conditions.

Data sheet st	Data sheet status							
Product	This data sheet contains final product specifications.							
specification								
Limiting valu	les							
Limiting valu	es given are in accordance with the Absolute Maximum Rating System (IEC							
134). Stress a	bove one or more of the limiting values may cause permanent damage to the							
device. These	are stress ratings only and operation of the device at these or at any other							
conditions ab	ove those given in the Characteristics sections of the specification is not implied.							
Exposure to li	Exposure to limiting values for extended periods may affect device reliability.							
Application information								
Where application information is given, it is advisory and does not form part of the								
specification.								

eliability test			
TEST	CONDITION	METHOD	REMARK
High-Temperature Operation	T = +50°C, RH = 30% for 240 hrs	IEC 60 068-2-2Bp	At the end of the test, electric, mechanical, and optical specifications shall be satisfied.
Low-Temperature Operation	T = 0°C for 240 hrs	IEC 60 068-2-2Ab	At the end of the test, electric, mechanical, and optical specifications shall be satisfied.
High-Temperature Functional	T = +60°C, RH=26% for 240 hrs	IEC 60 068-2-2Bp	At the end of the test, electric, mechanical, specifications shall be satisfied.
Low-Temperature Functional	T = -10°C for 240 hrs	IEC 60 068-2-2Ab	At the end of the test, electric, mechanical, specifications shall be satisfied.
High-Temperature Storage	T = +70°C, RH=23% for 240 hrs	IEC 60 068-2-2Bp	At the end of the test, electric, mechanical, and optical specifications shall be satisfied.
Low-Temperature Storage	T = -25°C for 240 hrs	IEC 60 068-2-1Ab	At the end of the test, electric, mechanical, and optical specifications shall be satisfied.
High-Temperature, High-Humidity Operation	T = +40°C, RH = 90% for 168 hrs	IEC 60 068-2-3CA	At the end of the test, electric, mechanical, specifications shall be satisfied.
High Temperature, High- Humidity Storage	T = +60℃, RH=80% for 240hrs	IEC 60 068-2-3CA	At the end of the test, electric, mechanical, specifications shall be satisfied.
Temperature Cycle	1 cycle:[-25℃ 30min]→[+70 ℃ 30 min] : 100 cycles	IEC 60 068-2-14	At the end of the test, electric, mechanical, specifications shall be satisfied.
UV exposure Resistance	765 W/m ² for 168hrs,40 $^\circ\!\mathrm{C}$	IEC60 068-2-5Sa	Optical characteristics shall be satisfied.
Package Vibration	1.04G, Frequency: 10~500Hz Direction: X,Y,Z Duration: 1 hours in each direction	Full packed for shipment	At the end of the test, electric, mechanical, and optical specifications shall be satisfied.
Package Drop Impact	Drop from height of 122 cm on concrete surface. Drop sequence: 1 corner, 3 edges, 6 faces One drop for each.	full packed for shipment	At the end of the test, electric, mechanical, and optical specifications shall be satisfied.
Electrostatic Effect (non-operating)	Machine model +/− 250V, 0Ω, 200pF	IEC 62179, IEC 62180	At the end of the test, electric, mechanical, specifications shall be satisfied.
Altitude test Operation	700hPa (= 3000m) 48Hr		At the end of the test, electric, mechanical, specifications shall be satisfied.
	TESTHigh-Temperature OperationLow-Temperature OperationHigh-Temperature FunctionalLow-Temperature FunctionalHigh-Temperature StorageLow-Temperature StorageHigh-Temperature StorageHigh-Temperature, High-Humidity OperationHigh-Temperature, High-Humidity StoragePackage VibrationPackage Drop ImpactElectrostatic Effect (non-operating)Altitude test	TESTCONDITIONHigh-Temperature OperationT = +50°C, RH = 30% for 240 hrsLow-Temperature FunctionalT = 0°C for 240 hrsHigh-Temperature FunctionalT = +60°C, RH=26% for 240 hrsLow-Temperature FunctionalT = -10°C for 240 hrsHigh-Temperature StorageT = +70°C, RH=23% for 240 hrsLow-Temperature StorageT = -25°C for 240 hrsHigh-Temperature StorageT = -25°C for 240 hrsHigh-Temperature, High-Humidity OperationT = +40°C, RH = 90% for 168 hrsHigh-Temperature, High-Humidity StorageT = +60°C, RH=80% for 240hrsUV exposure Resistance765 W/m² for 168hrs,40°C10V exposure Resistance765 W/m² for 168hrs,40°CPackage VibrationDirection: X,Y,Z Duration: 1 hours in each directionPackage Drop ImpactDrop from height of 122 cm on concrete surface. Drop sequence: 1 corner, 3 edges, 6 faces One drop for each.Electrostatic Effect (non-operating)Machine model +/- 250V, 0\Omega, 200pFAltitude test700hPa (= 3000m)	TESTCONDITIONMETHODHigh-Temperature Operation $T = +50^{\circ}C$, RH = 30% for 240 hrsIEC 60 068-2-2BpLow-Temperature Operation $T = 0^{\circ}C$ for 240 hrsIEC 60 068-2-2AbHigh-Temperature Functional $T = +60^{\circ}C$, RH=26% for 240 hrsIEC 60 068-2-2BpLow-Temperature Functional $T = -10^{\circ}C$ for 240 hrsIEC 60 068-2-2AbHigh-Temperature Storage $T = -10^{\circ}C$ for 240 hrsIEC 60 068-2-2AbHigh-Temperature Storage $T = -75^{\circ}C$ for 240 hrsIEC 60 068-2-2BpLow-Temperature Storage $T = -25^{\circ}C$ for 240 hrsIEC 60 068-2-2AbHigh-Temperature Storage $T = -25^{\circ}C$ for 240 hrsIEC 60 068-2-1AbHigh-Temperature, High-Humidity Operation $T = +40^{\circ}C$, RH = 90% for 168 hrsIEC 60 068-2-3CAHigh Temperature, High-Humidity Storage $T = +60^{\circ}C$, RH=80% for 240hrsIEC 60 068-2-3CATemperature Cycle $1 \text{ cycle:}[-25^{\circ}C 30 \min] \rightarrow [+70]$ $C 30 \min] : 100 \text{ cycles}IEC 60068-2-14UV exposureResistance765 \text{ W/m}^2 for 168hrs, 40°CIEC 60068-2-5SaPackage VibrationDrop from height of 122 cmon concrete surface.Drop Sequence: 1 corner, 3edges, 6 facesOne drop for each.full packed forshipmentElectrostatic Effect(non-operating)Machine model+/- 250V, 0\Omega, 200pFIEC 62179,IEC 62180Altitude test700hPa (= 3000m)IEC 62180$



15	Altitude test Storage	260hPa (= 10000m) 48Hr		At the end of the test, electric, mechanical, specifications shall be satisfied.
16	Stylus Tapping	POLYACETAL Pen: Top R:0.4mm Load: 300gf Speed: 5times/sec Total 13,500times,	Test should be done with a bezel	Pass criteria – no diass

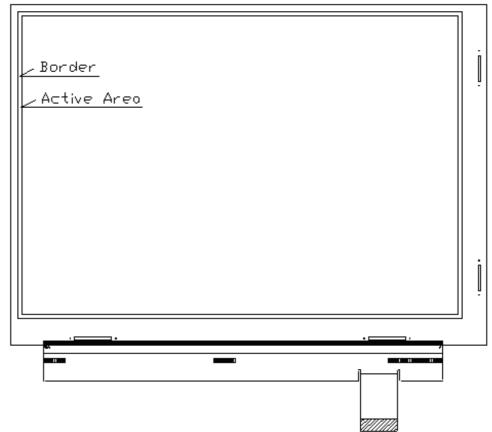
Actual EMC level to be measured on customer application

11. Bar Code definition

$\begin{array}{c ccccccccccccccccccccccccccccccccccc$
ED060SC4:E0R
2 : Internal control codes:
3 : FPL reversion code
V110:4
4 : FPL batch code:
(BL/P/B)001~009:01~99, 100~109:A0~A9, 110-119:B0~B9 320~329:Z0~Z9
5 : Year:
F:2005 / G:2006 / H:2007 / I:2008 / / Z:2025
6 : Month:
1:Jan. 2:Feb 9:Sep. A:Oct. B:Nov. C:Dec.
7 : Serial number
8 : MFG code:
TOC:T, PVI:P



12. Border definition



13.Block Diagram

